



UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE
United States Patent and Trademark Office
Address: COMMISSIONER FOR PATENTS
P.O. Box 1450
Alexandria, Virginia 22313-1450
www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/604,514	07/28/2003	Masuhiro Natsuvara	039.0020	1513
29453	7590	11/15/2007		
Judge Patent Associates Dojima Building, 5th Floor 6-8 Nishitemma 2-Chome, Kita-ku Osaka-Shi, 530-0047 JAPAN			EXAMINER	
			KACKAR, RAM N	
			ART UNIT	PAPER NUMBER
			1792	
			MAIL DATE	DELIVERY MODE
			11/15/2007	PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

Office Action Summary	Application No.	Applicant(s)
	10/604,514	NATSUHARA ET AL.
Examiner	Art Unit	
Ram N. Kackar	1792	

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) Responsive to communication(s) filed on 9/26/2007.
- 2a) This action is FINAL. 2b) This action is non-final.
- 3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) Claim(s) 1-4-6 and 8-19 is/are pending in the application.
- 4a) Of the above claim(s) _____ is/are withdrawn from consideration.
- 5) Claim(s) _____ is/are allowed.
- 6) Claim(s) 1-4-6 and 8-19 is/are rejected.
- 7) Claim(s) _____ is/are objected to.
- 8) Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) The specification is objected to by the Examiner.
- 10) The drawing(s) filed on _____ is/are: a) accepted or b) objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
a) All b) Some * c) None of:
 1. Certified copies of the priority documents have been received.
 2. Certified copies of the priority documents have been received in Application No. _____.
 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

1) <input type="checkbox"/> Notice of References Cited (PTO-892)	4) <input type="checkbox"/> Interview Summary (PTO-413)
2) <input type="checkbox"/> Notice of Draftsperson's Patent Drawing Review (PTO-948)	Paper No(s)/Mail Date. _____
3) <input type="checkbox"/> Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date _____	5) <input type="checkbox"/> Notice of Informal Patent Application (PTO-152)
	6) <input type="checkbox"/> Other: _____

DETAILED ACTION

Continued Examination Under 37 CFR 1.114

1. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on 9/5/2007 has been entered.

Claim Rejections - 35 USC § 102

2. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

3. **Claims 1, 4, 6, 9, 11-12 and 14 are rejected under 35 U.S.C. 102(b) as anticipated by or, in the alternative, under 35 U.S.C. 103(a) as obvious over Harada et al (WO 0154188).**

Harada et al disclose an electrostatic chuck with porous metallic electrode of tungsten or molybdenum or tantalum with a porosity of 1-7% (See Col 3 lines 26-46, Col 6 lines 15-25 and Col 10 lines 40-47 in US 6771483- an English equivalent).

Regarding the electrode being sinter laminae, it is noted that it is only a product by process limitation.

Product-by-process claims are not limited to the manipulations of the recited steps, only the structure implied by the steps. The patentability of a product does not depend on its method

of production. If the product in the product-by-process claim is the same as or obvious from a product of the prior art, the claim is unpatentable even though the prior product was made by a different process.” In re Thorpe, 777 F.2d 695, 698, 227 USPQ 964, 966 (Fed. Cir. 1985).

Claim Rejections - 35 USC § 103

4. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

5. Claims 1, 4-6 and 8-19 are rejected under 35 U.S.C. 103(a) as being unpatentable over Shamouilian et al (US 6494958) in view of Heimann et al (US 6620707).

Shamouilian et al disclose a wafer holder for a semiconductor manufacturing equipment (Fig 1-210) having a surface for carrying wafers and an electrical circuitry (electrode) formed inside (Fig 1-220 or 230), the electrical circuitry having porosity (large range of mesh size of 5-200 - Col 9 lines 42-46) and comprising silver, molybdenum, tantalum, tungsten or platinum (Col 9 lines 33-38). The electrode could be an RF electrode (Col 5 lines 48-50) or an electrostatic chuck (Col 4 lines 35-37). The wafer holder including the electrode could be made by sintering (Col 7 lines 9-14).

Shamouilian et al teach that due to voids or interstices between the wires (pores) the mesh is subject to less thermal expansion. It is therefore obvious that adjustment of mesh size

could allow adjustment of thermal expansion and the integrity of the wafer holder through large number of cycles of expansion and contraction.

Regarding the limitation of porosity being 0.1% -40% the mesh size could control the porosity of the electrode to any percentage needed.

Sintered electrode of platinum for heating is disclosed by Heimann et al (Col 1 lines 48-57) who teach that electrodes are usually manufactured by sintering (Col 1 lines 30-32) and disclose the pros and cons of low porosity vs high porosity and recommends suitable sintering temperature for porosity required. Heimann et al teach that for assuring a sufficient current carrying capacity of heating conductor its porosity should be as low as possible and goes on to say that porosity can be substantially influenced by temperature so that high temperature is required for a dense structure. The heating electrode is disclosed comprising platinum powder and aluminum oxide powder (Abstract and Col 1 lines 48-57).

It is held that it is obvious to optimize Result-Effective Variables MPEP 2144.05 II B In re Antonie, 559 F.2d 618, 195 USPQ 6 (CCPA 1977) See also In re Boesch, 617 F.2d 272, 205 USPQ 215 (CCPA 1980). It is clear from the teaching of Heimann et al that the porosity is a result effective parameter.

Therefore it would have been obvious for one of ordinary skill in the art at the time of invention to make the electrode as sintered as an alternative and art recognized equivalent to porous mesh and have a porosity of 0.1-40%.

Regarding claim 14 it is obvious that when the porosity could be as low as 0.1% there pores will not have an average diameter bigger than the electrode.

6. Claims 1, 4-6 and 8-19 are rejected under 35 U.S.C. 103(a) as being unpatentable over Kuibira et al (US 20020007911) in view of Heimann et al (US 6620707).

Kuibira et al et al disclose a substrate holder with sintered metal electrode of tungsten, molybdenum, silver, palladium, platinum, nickel and chromium. The electrode could comprising metal powder and sintering agent (Paragraph 81). Further the sintering agent could be yttria (Paragraph 87).

Kuibira et al do not disclose porosity.

However sintering leaves more or less porosity according to sintering temperature.

As disclosed above, sintered electrode of platinum for heating is disclosed by Heimann et al (Col 1 lines 48-57) who teach that electrodes are usually manufactured by sintering (Col 1 lines 30-32) and disclose the pros and cons of low porosity vs. high porosity and recommends suitable sintering temperature for porosity required. Heimann et al teach that for assuring a sufficient current carrying capacity of heating conductor its porosity should be as low as possible and goes on to say that porosity can be substantially influenced by temperature so that high temperature is required for a dense structure. The heating electrode is disclosed comprising platinum powder and aluminum oxide powder (Abstract and Col 1 lines 48-57).

Therefore it would have been obvious for one of ordinary skill in the art at the time of invention to control the sintering process of Kuibira et al to get a porosity for best performance of the electrode.

7. Claims 1, 4-6 and 8-19 are rejected under 35 U.S.C. 103(a) as being unpatentable over Niori et al (US 6197246) in view of Heimann et al (US 6620707).

Niori et al disclose a wafer holder for a semiconductor manufacturing equipment (Fig 7-41) having a surface for carrying wafers and an electrical circuitry (electrode) formed inside (30), the electrical circuitry having porosity (mesh size) and comprising molybdenum, tantalum, tungsten or platinum (Col 10 lines 57 to Col 11-line8). The electrode could be an RF electrode (Fig 7). Niori et al further teach that in an electrode of wire mesh or plate like with numerous holes (porous), the thermal stress is dispersed (Col 10 lines 65-67).

Regarding the porosity the mesh size could control the porosity to a required degree.

AS discussed above sintered electrode of platinum for heating is disclosed by Heimann et al (Col 1 lines 48-57) who teach that electrodes are usually manufactured by sintering (Col 1 lines 30-32) and disclose the pros and cons of low porosity vs. high porosity and recommends suitable sintering temperature for porosity required. Heimann et al teach that for assuring a sufficient current carrying capacity of heating conductor its porosity should be as low as possible and goes on to say that porosity can be substantially influenced by temperature so that high temperature is required for a dense structure. The heating electrode is disclosed comprising platinum powder and aluminum oxide powder (Abstract and Col 1 lines 48-57).

Therefore it would have been obvious for one of ordinary skill in the art at the time of invention to make the electrode as sintered as an alternative and art recognized equivalent to porous mesh according to the teachings of Niori et al and Heimann et al.

Response to Arguments

Applicant's arguments filed 9/5/2007 have been fully considered but they are not persuasive.

Sec 112 rejection of claim 14 is removed, in view of applicant's statement that it would be inherent for sinter laminae. However, this dependent claim therefore does nothing to further limit the independent claim. Further, office action never stated that mesh and sinter laminae are same. They however are obviously variant and equivalent.

Applicant's argument that "the porosity is adjusted not only according to the addition quantities of binder and solvent, but also according to how much binder/solvent volume is added. The prior art of record, in contrast, while mentioning the addition of binder and solvent in making the paste, is silent as regards to what levels these ingredients are added" is not understood.

It does not appear to be commensurate with the scope of the claims.

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Ram N. Kackar whose telephone number is 571 272 1436. The examiner can normally be reached on M-F 8:00 A.M to 5:P.M.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Parviz Hassanzadeh can be reached on 571 272 1435. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Art Unit: 1792

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

Ram

Ram Kackar
Primary Examiner AU 1763